

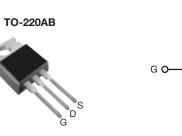
Vishay Siliconix

RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.20				
Q _g (Max.) (nC)	11				
Q _{gs} (nC)	3.1				
Q _{gd} (nC)	5.8				
Configuration	Single				



S N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ14PbF
	SiHFZ14-E3
SnPb	IRFZ14
	SiHFZ14

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage ^f			V _{DS}	60	V	
Gate-Source Voltage ^f			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	I _D	10		
		T _C = 100 °C		7.2	А	
Pulsed Drain Current ^a			I _{DM}	40		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	47	mJ	
Maximum Power Dissipation	aximum Power Dissipation T _C = 25 °C			43	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d]	
Manuatian Tanana	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V; starting T_J = 25 °C, L = 1.47 mH, R_g = 25 Ω , I_{AS} = 8 A (see fig. 12).

c. $I_{SD} \leq$ 10 A, dI/dt \leq 90 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	1	1 _				1		
PARAMETER	SYMBOL	ТҮР	•	MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - - 3.5			°C/W			
Case-to-Sink, Flat, Greased Surface	R _{thCS}							
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 °C, u	unless otherw	vise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static							1	1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	50 µA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I	-	-	0.063	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	-	= V _{GS} , I _D = 2		2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	-	$V_{GS} = \pm 20 V$		-	-	± 100	nA
5			$V_{GS} = \pm 20 V$ $V_{DS} = 60 V, V_{GS} = 0 V$		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}		, V _{GS} = 0 V, ⁻		-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		= 6.0 A ^b	-	-	0.20	Ω
Forward Transconductance	g _{fs}		= 25 V, I _D = 6		2.4	-	-	S
Dynamic						•		I
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	300	-		
Output Capacitance	C _{oss}			-	160	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	29	-		
Total Gate Charge	Qq				-	-	11	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V} \qquad \begin{array}{c} I_{D} = 10 \text{ A}, V_{DS} = 48 \text{ V},\\ \text{see fig. 6 and } 13^{\text{b}} \end{array}$		-	-	3.1	nC	
Gate-Drain Charge	Q _{gd}			-	-	5.8		
Turn-On Delay Time	t _{d(on)}				-	10	-	
Rise Time	tr	V _{DD} = 30 V, I _D = 10 A,		-	50	-	1	
Turn-Off Delay Time	t _{d(off)}	R _g =	$R_g = 24 \Omega, R_D = 2.7 \Omega,$ see fig. 10 ^b		-	13	-	ns
Fall Time	t _f	-	555 lig. 10		-	19	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	40	~	
Body Diode Voltage	V _{SD}	T _J = 25 °C	$T_{J} = 25 \text{ °C}, I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	10 4 - 11/1	H 100 A/ -b	-	70	140	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	0.20	0.40	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			on is dor	ninated b	y L _S and	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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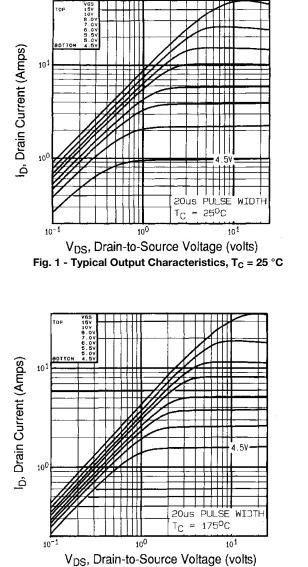


Fig. 2 - Typical Output Characteristics, $T_c = 175$ °C

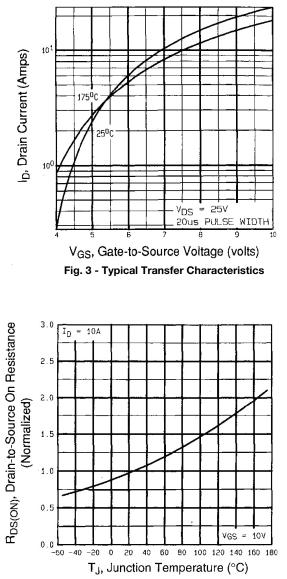
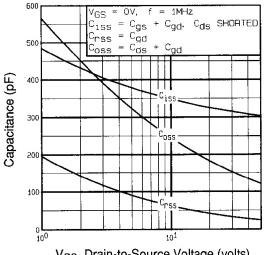


Fig. 4 - Normalized On-Resistance vs. Temperature

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V_{DS}, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

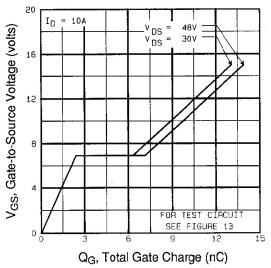
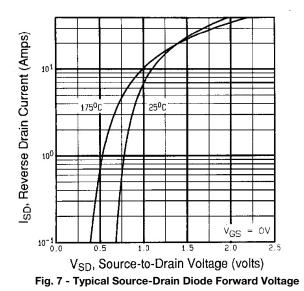
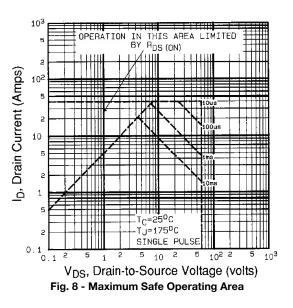


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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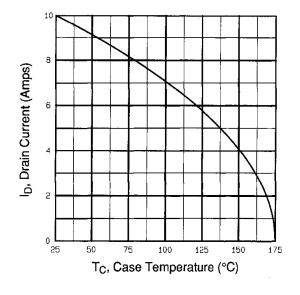


Fig. 9 - Maximum Drain Current vs. Case Temperature

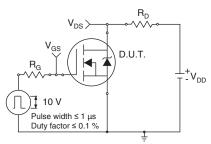


Fig. 10a - Switching Time Test Circuit

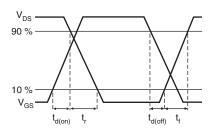
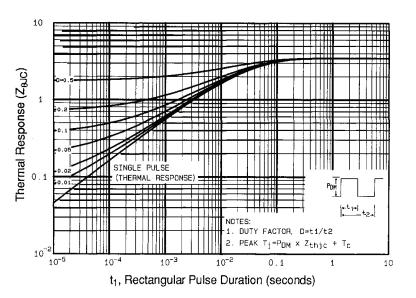
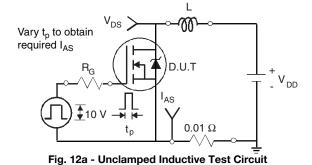


Fig. 10b - Switching Time Waveforms







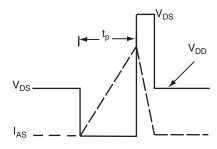


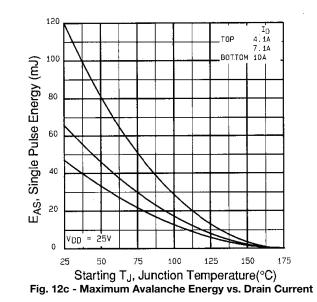
Fig. 12b - Unclamped Inductive Waveforms

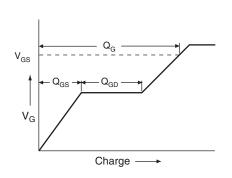
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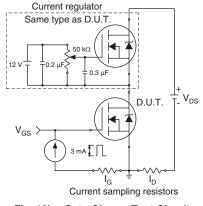
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Peak Diode Recovery dV/dt Test Circuit

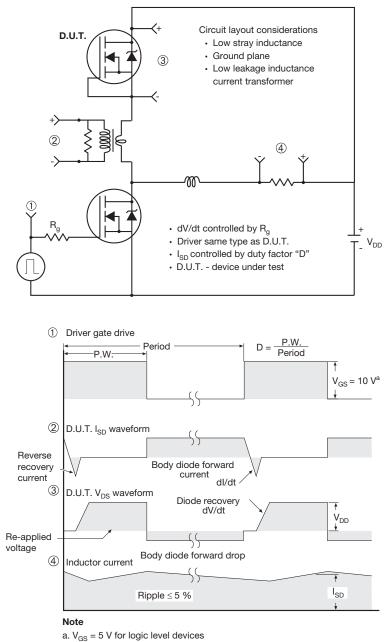


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91289.

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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